

PATENT ASSIGNMENT

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|----------------|----------------|
| Byung-Hee SOHN | 07/01/2010 |
| Young-Suk JUNG | 07/01/2010 |
| Seong YANG | 07/01/2010 |
| Sang-Mo KIM | 07/01/2010 |
| Eun-Seog CHO | 07/01/2010 |

RECEIVING PARTY DATA

| | |
|-----------------|--------------------------------|
| Name: | SAMSUNG ELECTRONICS CO., LTD. |
| Street Address: | 416, Maetan-dong, Yeongtong-gu |
| City: | Suwon-si, Gyeonggi do |
| State/Country: | REPUBLIC OF KOREA |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 12831805 |

CORRESPONDENCE DATA

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| NAME OF SUBMITTER: | Leah M. Reimer |
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Total Attachments: 2
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OP \$40.00 12831805

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**PATENT
 REEL: 024659 FRAME: 0248**

ASSIGNMENT

WHEREAS WE, **Byung-Hee SOHN** of 106-1906, SK Apt., Seocheon-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea; **Young-Suk JUNG** of 135-1002, Sinmaetan Weve Haneulchae Apt., Maetan 3-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea; **Yoo-Seong YANG** of 104-702, Hyundai Morningside 2 Cha Apt., Bora-dong, Giheung-gu, Gyeonggi-do, Republic of Korea; **Sang-Mo KIM** of 910-2103, Dongtan Prun Maeul Posco Thesharp, 1134, Neung-dong, Hwaseong-si, Gyeonggi-do, Republic of Korea; and **Eun-Seog CHO** of 101-401, Seogwang Apt., Wolgye 3-dong, Nowon-gu, Seoul, Republic of Korea (hereinafter collectively referred to as the “**ASSIGNORS**”), have invented certain new and useful improvements in:

POLYAMIC ACID, POLYIMIDE, MANUFACTURING METHOD THEREOF, AND POLYIMIDE FILM

(hereinafter referred to as the “**INVENTION**”) which claims priority to Korean Application No. 10-2009-0121467, filed on 8 December 2009; and for which we are about to file an application for a United States Patent (hereinafter collectively referred to as the “**APPLICATIONS**”);

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as “**ASSIGNEE**”), a corporation organized and existing under the laws of the Country of KOREA, having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea**, is desirous of acquiring an interest in any and all countries, in and to the **INVENTION**, the **APPLICATIONS**, and any and all Patents to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, we, the **ASSIGNORS**, have assigned and transferred, and hereby assign and transfer unto **ASSIGNEE**, the entire right, title and interest in and to the **INVENTION**, the **APPLICATIONS**, and any and all Patents that may be issued therefrom, in any and all countries, including any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to **ASSIGNEE**; and we do hereby agree that we will execute all papers necessary in connection with any and all patent applications when called upon to do so by **ASSIGNEE**, its successors or assigns, and that we will, at the cost and expense

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of ASSIGNEE, fully assist and cooperate in all matters in connection with any and all patent applications and Patents issuing thereon.

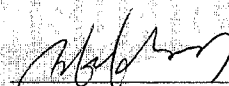
The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the APPLICATIONS or any Patents issuing thereon.

Date: July 1, 2010 _____ L.S.



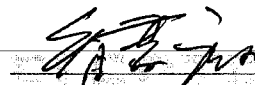
Byung-Hee SOHN

Date: July 1, 2010 _____ L.S.



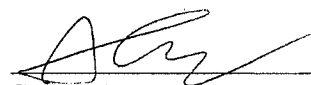
Young-Suk JUNG

Date: July 1, 2010 _____ L.S.



Yoo-Seong YANG

Date: July 1, 2010 _____ L.S.



Sang-Mo KIM

Date: July 1, 2010 _____ L.S.



Eun-Seog CHO